

PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1
 Stylesheet Version v1.2

EPAS ID: PAT3159312

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
HONG YANG	12/05/2014
WENWU WANG	12/05/2014
JIANG YAN	12/05/2014
WEICHUN LUO	12/05/2014
RECEIVING PARTY DATA	
Name:	INSTITUTE OF MICROELECTRONICS, CHINESE ACADEMY OF SCIENCES
Street Address:	NO.3 BEITUCHENG WEST ROAD, CHAOYANG DISTRICT
City:	BEIJING
State/Country:	CHINA
Postal Code:	100029
PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	14407210
CORRESPONDENCE DATA	
Fax Number:	(612)315-4321
<i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.</i>	
Phone:	612-315-4108
Email:	erickson@cfpatlaw.com
Correspondent Name:	JOHN P. FONDER
Address Line 1:	33 SOUTH SIXTH STREET
Address Line 2:	SUITE 3950
Address Line 4:	MINNEAPOLIS, MINNESOTA 55402
ATTORNEY DOCKET NUMBER:	5006.0016WU1
NAME OF SUBMITTER:	JULIE ERICKSON
SIGNATURE:	/Julie Erickson/
DATE SIGNED:	12/22/2014
Total Attachments: 2	
source=5006_0016WU1_Assignment#page1.tif	

ASSIGNMENT

WHEREAS, we, Hong YANG, of No.3 Beitucheng West Road, Chaoyang District, Beijing 100029, China, Wenwu WANG, of No.3 Beitucheng West Road, Chaoyang District, Beijing 100029, China, Jiang YAN, of No.3 Beitucheng West Road, Chaoyang District, Beijing 100029, China, and Weichun LUO, of No.3 Beitucheng West Road, Chaoyang District, Beijing 100029, China, ("Assignors"), have invented certain new and useful improvements in METHOD FOR ADJUSTING EFFECTIVE WORK FUNCTION OF METAL GATE, for which an application for Letters Patent of the United States has been made, and which may be identified in the United States Patent Office by Application No. 14/407,210, filed December 11, 2014

WHEREAS, INSTITUTE OF MICROELECTRONICS, CHINESE ACADEMY OF SCIENCES, ("Assignee"), a business entity organized and existing under the laws of the Country of China, and having its principal offices at No.3 Beitucheng West Road, Chaoyang District, Beijing 100029, China is desirous of acquiring the entire right, title and interest in and to said invention, said application and in, to and under any and all Letters Patent to be obtained therefor,

NOW, THEREFORE, for and in consideration of good and valuable consideration paid by Assignee to Assignors, the receipt and sufficiency of which is hereby acknowledged by us, we have sold, assigned and transferred, and by these presents do hereby sell, assign and transfer unto the said Assignee, its successors and assigns, our entire right, title and interest in and to said invention, said application, all applications claiming priority to said application including all divisions, continuations or renewals thereof, and the Letters Patent, both foreign and domestic, that may or shall issue, therefrom including all reissues or extensions of such patents including all of our rights under the International Convention and further including the right to sue, counterclaim and recover for past, present and future infringement of the rights assigned or to be assigned, as fully and entirely as the same would have been held by the Assignors if this assignment had not been made, and we do hereby authorize and request the Commissioner of Patents to issue said Letters Patent to the above mentioned Assignee in accordance herewith.

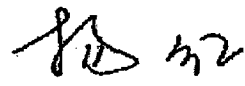
We hereby authorize the above-mentioned Assignee, its successors and assigns, or anyone it may properly designate, to insert in this instrument the date of execution and/or filing date and application number of said application when ascertained.

We further authorize said Assignee, its successors and assigns, or anyone it may properly designate, to apply for Letters Patent, in its own name if desired, in any and all foreign countries, and additionally to claim the filing date of said United States application and/or otherwise take advantage of the provisions of the International Convention.

Upon said consideration we do hereby covenant and agree with the said Assignee, its successors and assigns, that we will not execute in writing or do any act whatsoever conflicting with these presents, and that we or our executors or administrators will at any time upon request, without further or additional consideration, but at the expense of the said Assignee, its successors and assigns, execute such additional writings and do such additional acts as said Assignee, its successors and assigns, may deem necessary or desirable to perfect the Assignee's enjoyment of

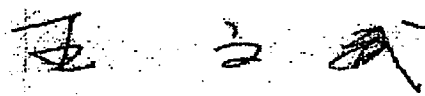
this grant, and render all necessary assistance in making application for and obtaining original, divisional, reissued or extended Letters Patent of the United States, or of any and all foreign countries on said invention, and in enforcing any rights occurring as a result of such applications or patents, by giving testimony in any proceedings or transactions involving such applications or patents.

Date: 5/12/2014
Day/Month/Year



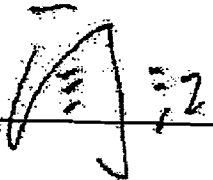
Hong YANG

Date: 5/12/2014
Day/Month/Year



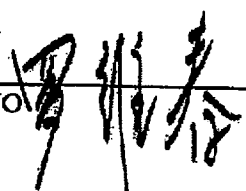
Wenwu WANG

Date: 5/12/2014
Day/Month/Year



Jiang YAN

Date: 5/12/2014
Day/Month/Year



Weichun LUO